

P39LF6QTKD

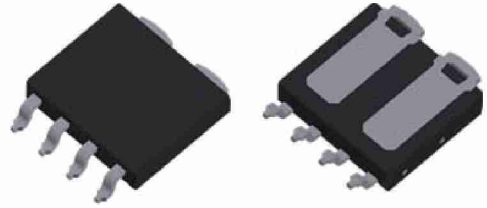
Power MOSFETs
60V, 39A, Dual N-channel

Feature

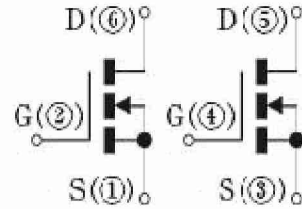
- N-channel
- Small SMD
- Dual type
- 4.5V Gate Drive
- Low Capacitance
- Based on AEC-Q101
- Halogen free
- Pb free terminal
- RoHS:Yes

OUTLINE

Package (House Name): LF_Dual



Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : Tc=25°C, per FET)

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	T _{stg}		-55 to 175	°C
Channel temperature	T _{ch}		-55 to 175	°C
Drain-source voltage	V _{DSS}		60	V
Gate-source voltage	V _{GSS}		±20	V
Continuous drain current(DC)	I _D		39	A
Continuous drain current(Peak)	I _{DP}	Pulse width 10μs, duty=1/100	117	A
Continuous source current(DC)	I _S		39	A
Total power dissipation	P _T	With heatsink	62	W
Total power dissipation	P _T	※	2.5	W
Total power dissipation	P _T	※	1.5	W
Single avalanche current	I _{AS}	Starting T _{ch} =25°C T _{ch} ≤150°C	22	A
Single avalanche energy	E _{AS}	Starting T _{ch} =25°C T _{ch} ≤150°C	54	mJ

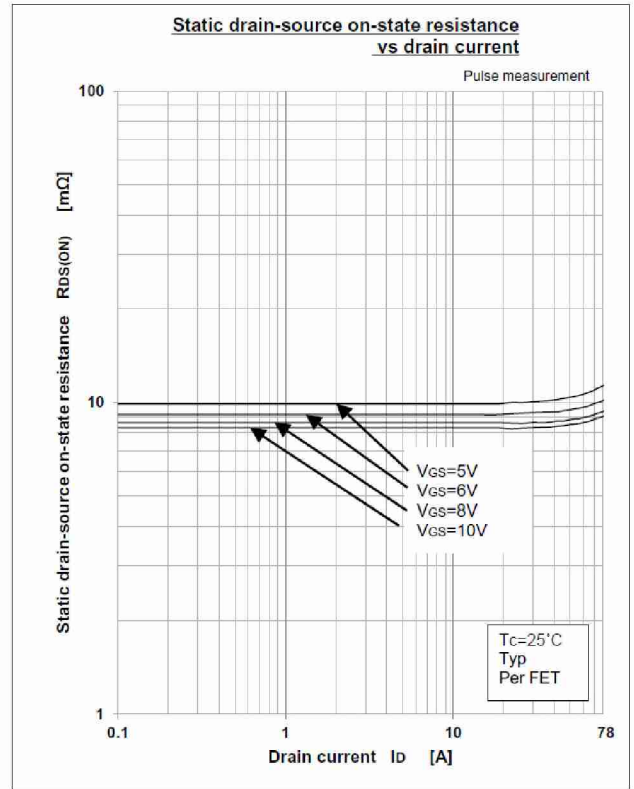
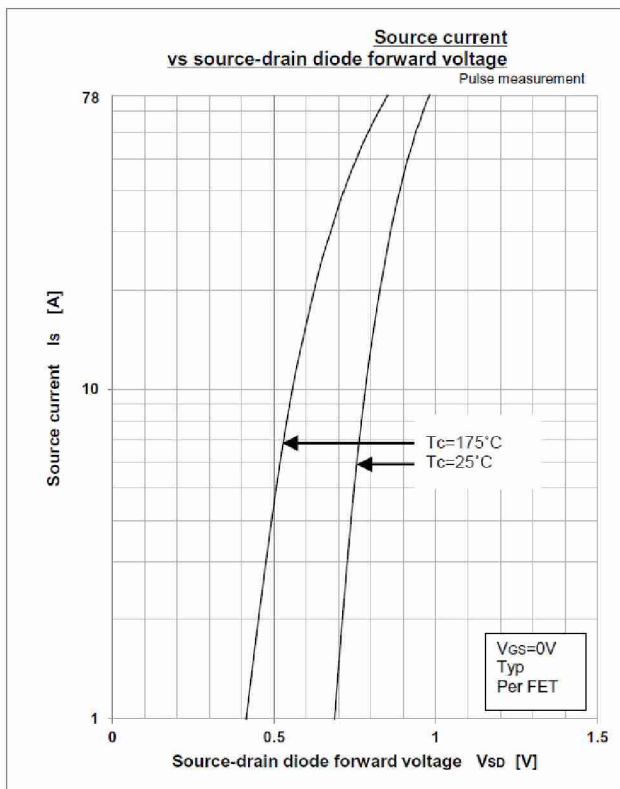
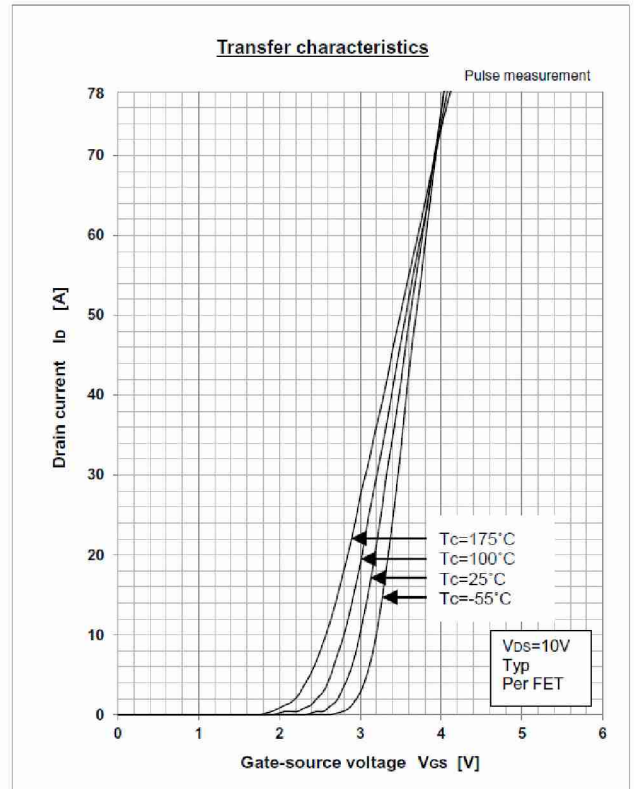
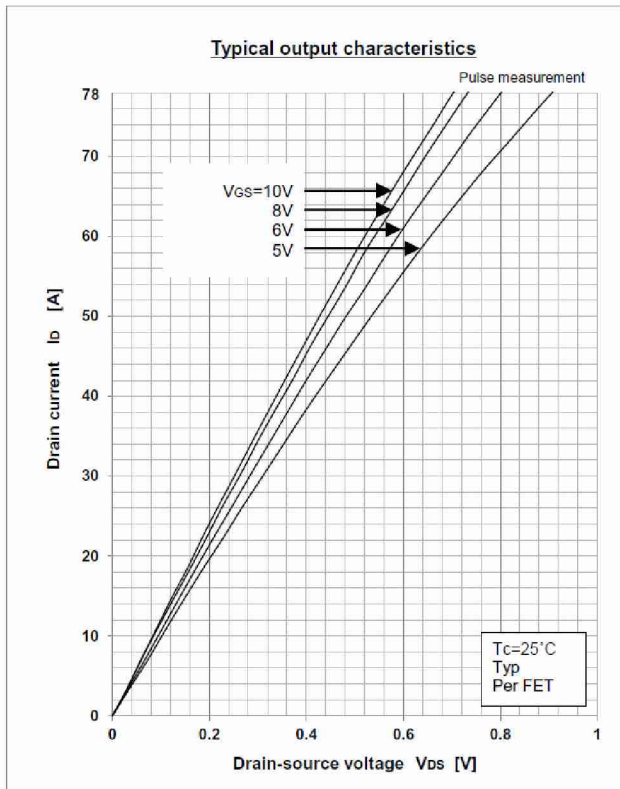
※ :See the original Specifications

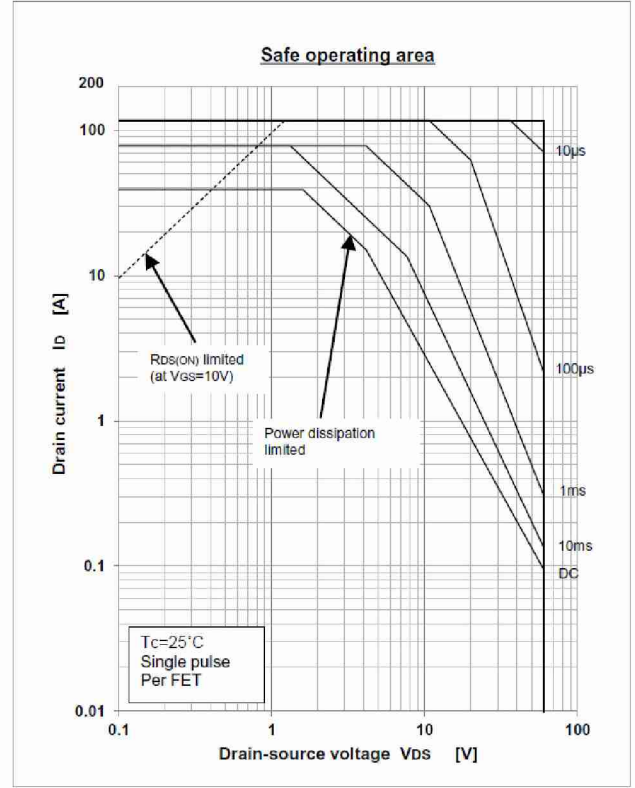
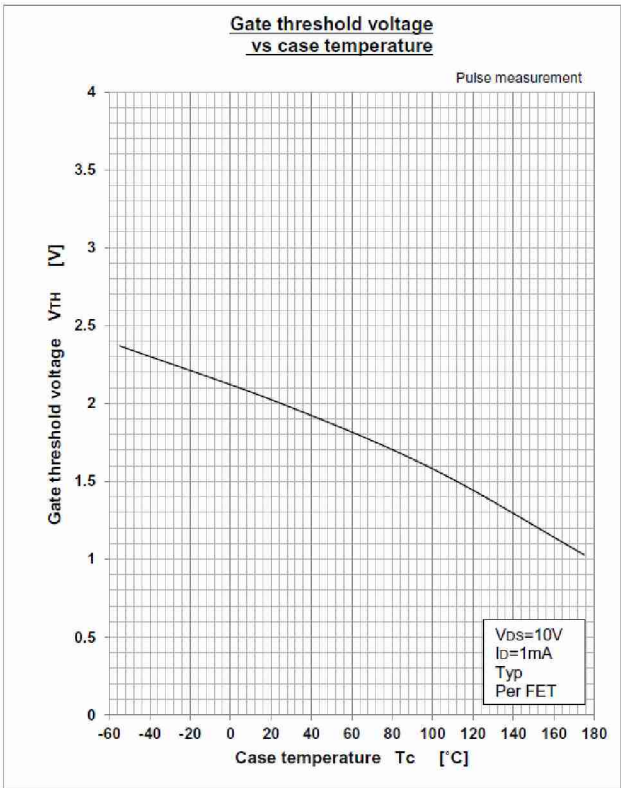
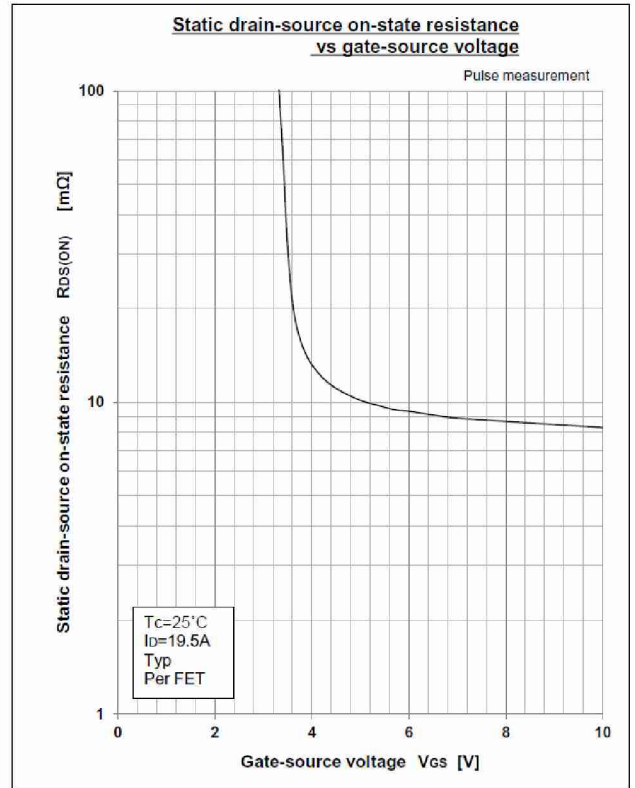
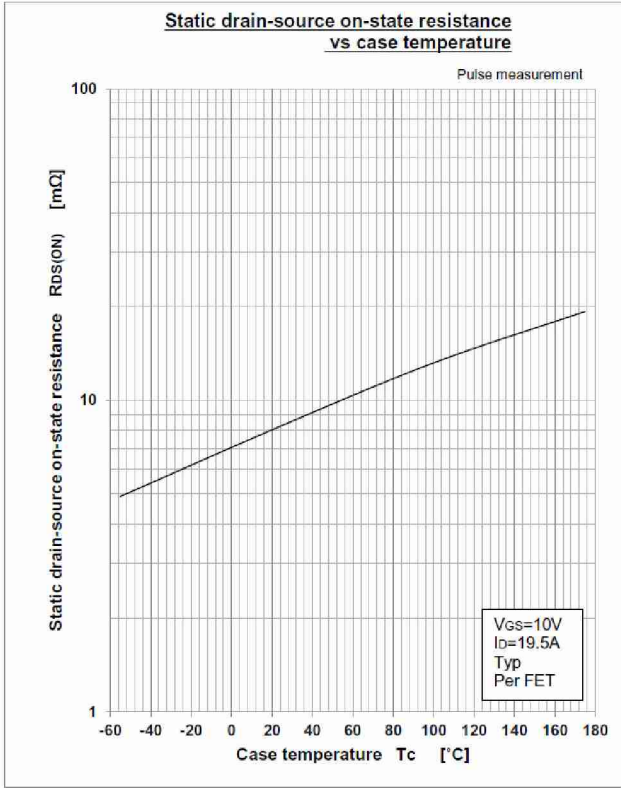
Electrical Characteristics (unless otherwise specified : Tc=25°C, per FET)

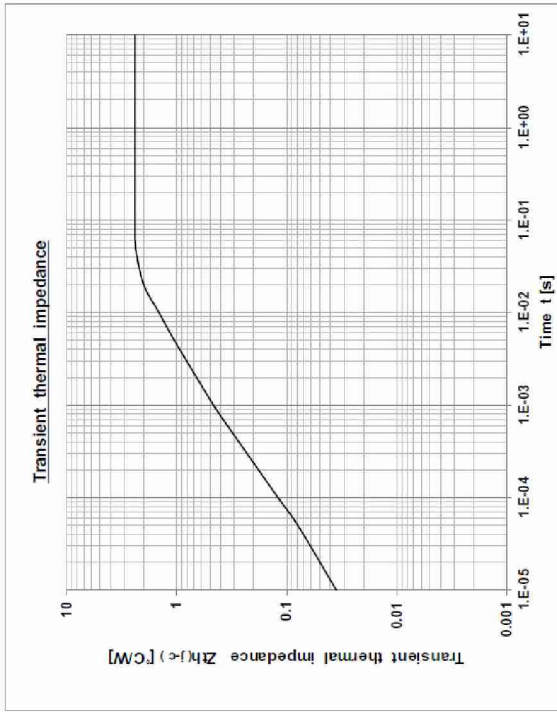
Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Drain-Source breakdown voltage	$V_{(BR)DSS}$	ID=1mA, VGS=0V	60			V
Zero gate voltage drain current	I_{DSS}	VDS=60V, VGS=0V			1	μA
Gate-source leakage current	I_{GSS}	VGS=±20V, VDS=0V			±0.1	μA
Forward transconductance	g_{fs}	ID=19.5A, VDS=10V	9			S
Static drain-source on-state resistance	$R_{DS(ON)}$	ID=19.5A, VGS=10V		0.0083	0.0104	Ω
Static drain-source on-state resistance	$R_{DS(ON)}$	ID=19.5A, VGS=4.5V		0.0111	0.0148	Ω
Gate threshold voltage	V_{th}	ID=1mA, VDS=10V	1.5	2	2.5	V
Source-drain diode forward voltage	V_{SD}	IS=39A, VGS=0V			1.2	V
Thermal resistance	$R_{th(j-c)}$	Junction to case, with heatsink			2.41	°C/W
Thermal resistance	$R_{th(j-a)}$	Junction to ambient ※			60	°C/W
Thermal resistance	$R_{th(j-a)}$	Junction to ambient ※			100	°C/W
Total gate charge	Q_g	VDD=48V, VGS=10V, ID=39A		35		nC
Gate to source charge	Q_{gs}	VDD=48V, VGS=10V, ID=39A		8		nC
Gate to drain charge	Q_{gd}	VDD=48V, VGS=10V, ID=39A		11		nC
Input capacitance	C_{iss}	VDS=25V, VGS=0V, f=1MHz		1765		pF
Reverse transfer capacitance	C_{rss}	VDS=25V, VGS=0V, f=1MHz		102		pF
Output capacitance	C_{oss}	VDS=25V, VGS=0V, f=1MHz		212		pF
Turn-on delay time	$t_{d(on)}$	ID=19.5A, RL=1.54Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		5.5		ns
Rise time	t_r	ID=19.5A, RL=1.54Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		16		ns
Turn-off delay time	$t_{d(off)}$	ID=19.5A, RL=1.54Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		20		ns
Fall time	t_f	ID=19.5A, RL=1.54Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		5		ns
Diode reverse recovery time	t_{rr}	IF=39A, VGS=0V, di/dt=100A/μs		39		ns
Diode reverse recovery charge	Q_{rr}	IF=39A, VGS=0V, di/dt=100A/μs		39		nC

※ :See the original Specifications

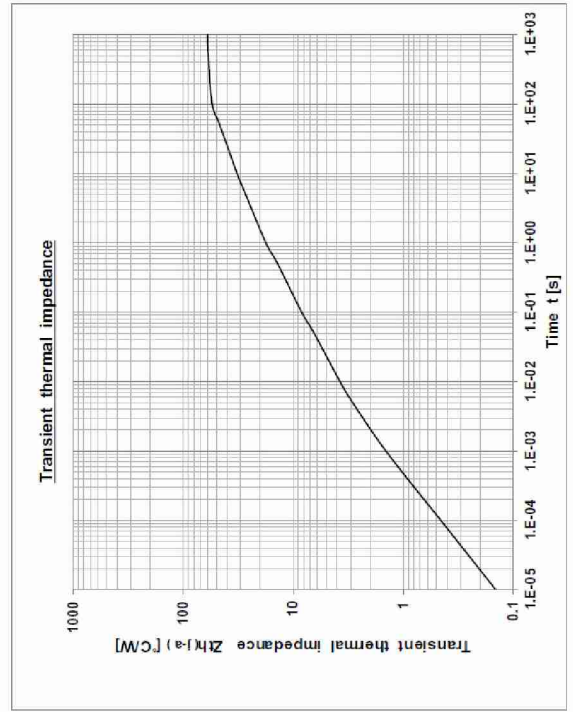
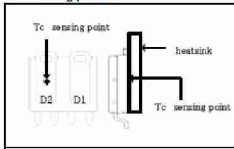
CHARACTERISTIC DIAGRAMS





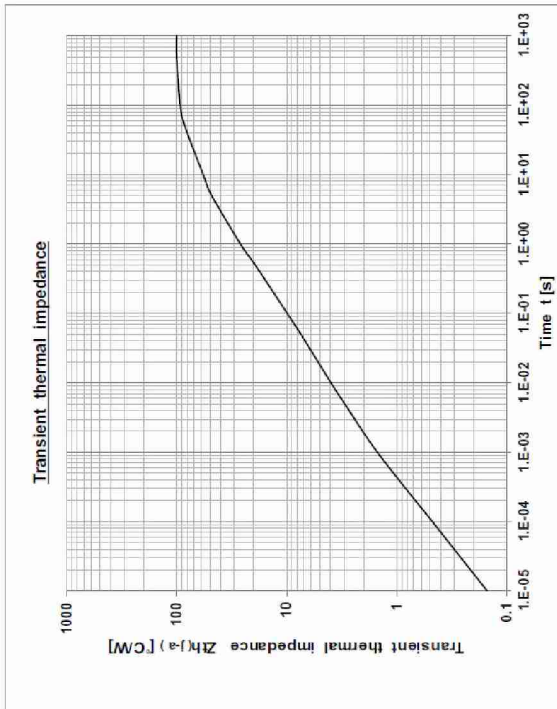


<Tc sensing point>



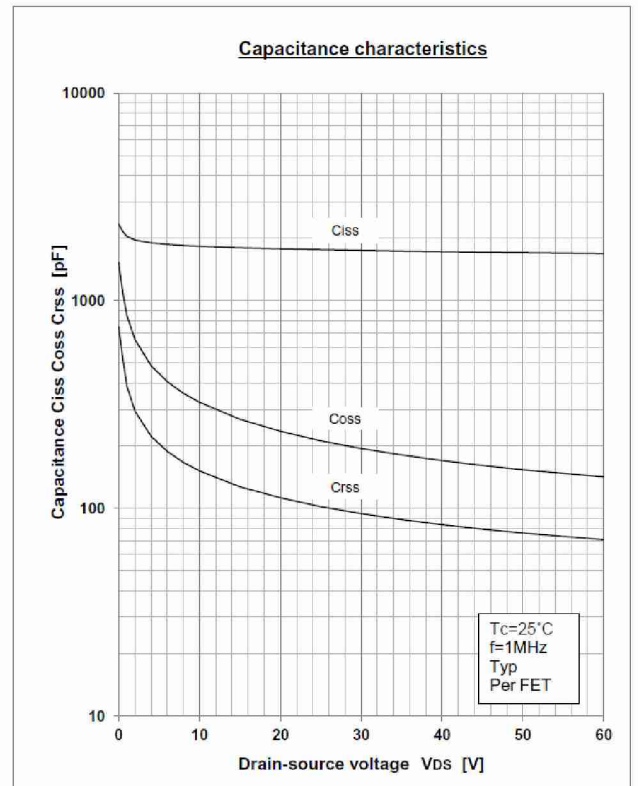
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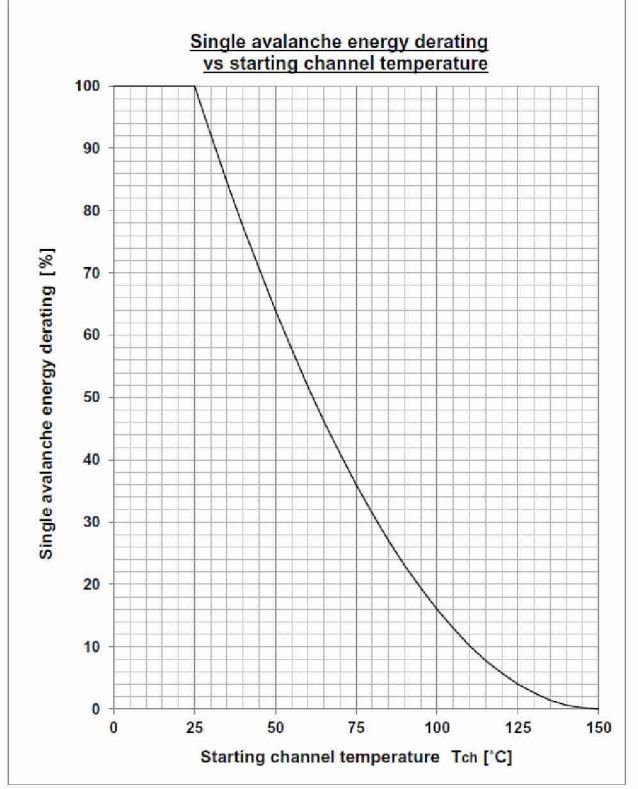
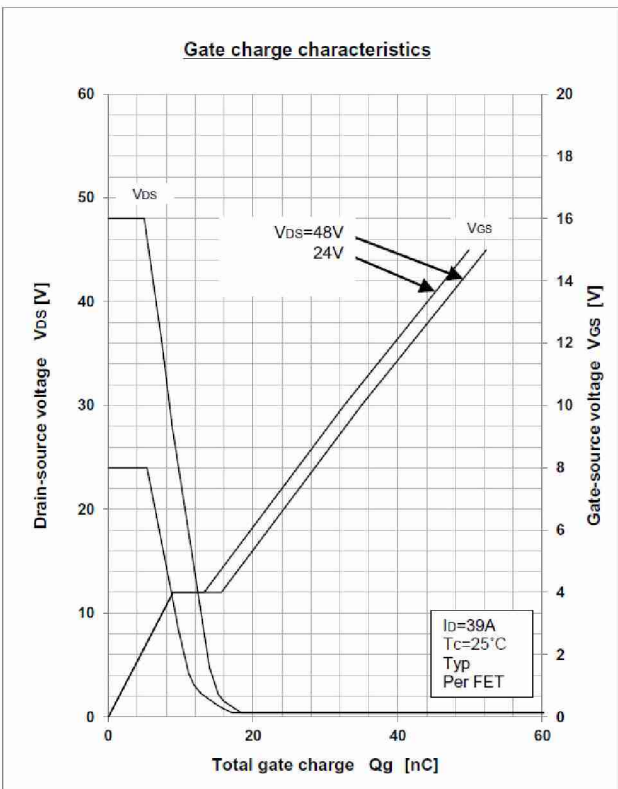
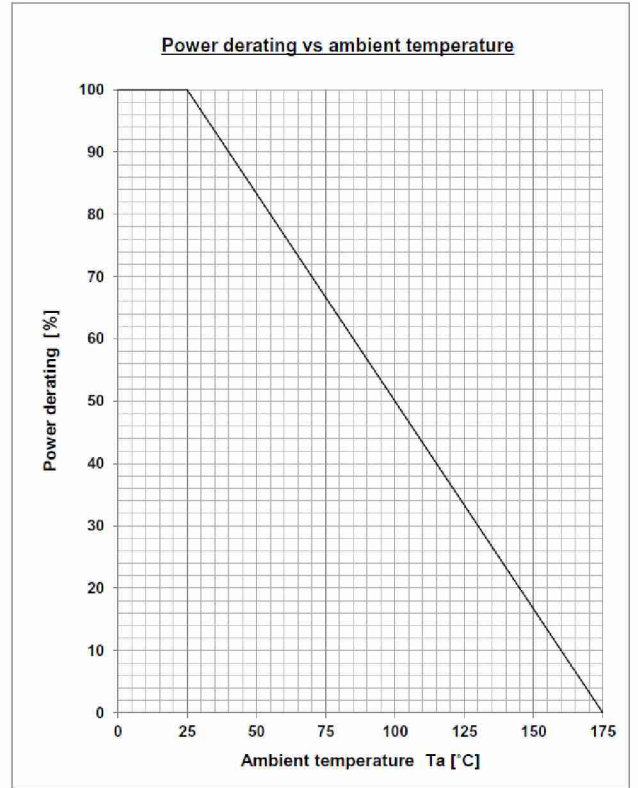
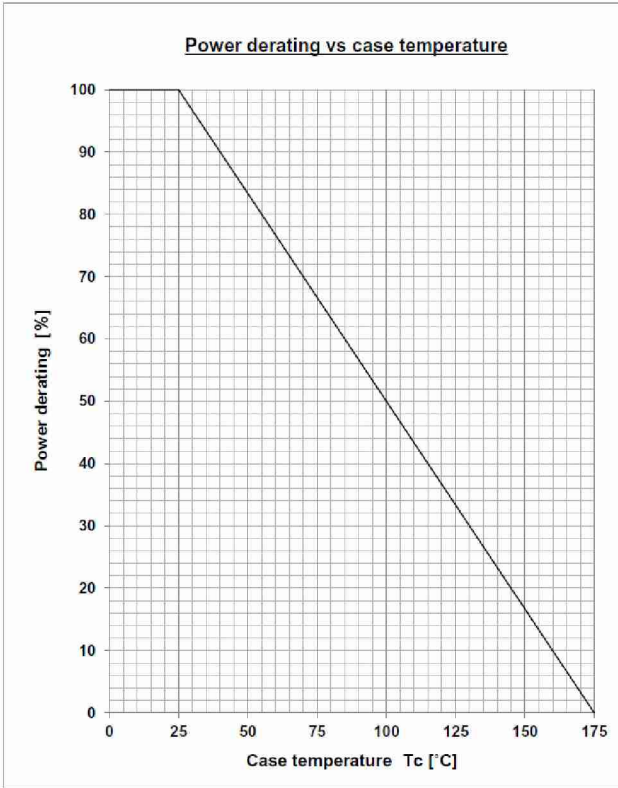
Type	Glass-epoxy
Size	1 Inch ²
Thickness	1.6 mm
Conductor thickness	70 μm
Pattern area	629.42 mm ²



<Substrate detail>

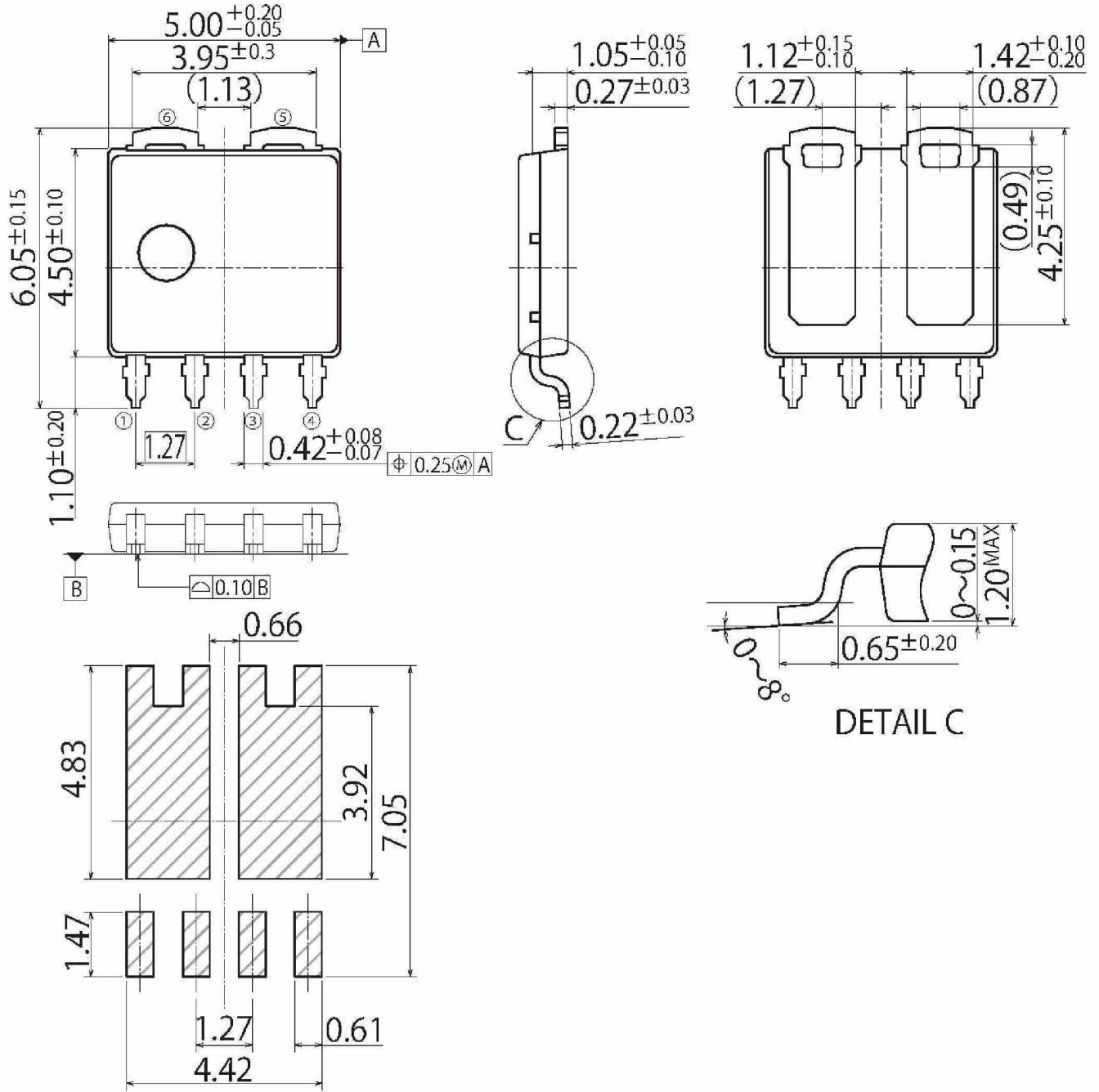
Type	Glass-epoxy
Size	1 Inch ²
Thickness	1.6 mm
Conductor thickness	70 μm
Pattern area	91.34 mm ²





G8

JEDEC Code	-
JEITA Code	-
House Name	LF_Dual



Referential Soldering Pad

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